USB PD and Type-C high voltage sink/source combo switch with protection Rev. 1.0 — 3 March 2025 Product data sheet

Rev. 1.0 — 3 March 2025

# **1** General description

The NX20P3483AUK is a product with combined multiple power switches and an LDO for USB PD application. The device includes a bidirectional high voltage power switch which supports both 20V sink and 6V source; a 5V power switch for source and a 100mA LDO provides power supply for dead battery operation.

The high voltage power switch has 29V DC tolerance, and is able to sink up to 5A at maximum of 20V and source up to 3.4A at maximum of 6V. When it is configured as a high voltage sink switch, the path has overvoltage protection and reverse current protection features. While it is configured as high voltage source switch, the adjustable overcurrent limit circuit is integrated.

The 5V power switch has an adjustable overcurrent limit, "ideal diode" feature and short circuit protection. The maximum current capability is 3.4A. It supports fast role swap for USB PD3.0 application.

A VBUS discharge circuit is integrated according to USB PD VBUS discharging requirement. To minimize inrush current during normal startup, turn on slew rate control has been built in for all power switches. Over temperature protection is also equipped to automatically isolate the switch terminals when the device is overheated.

The device is controlled through an  $I^2$ C-bus interface, allowing the host to configure switches and program different specified parameters according to an  $I^2$ C register map.

The NX20P3483AUK is offered with WLCSP42 package: 0.4mm pitch, 2.51 x 2.91 x 0.525mm, 0.4mm pitch.

# 2 Features and benefits

- Wide supply voltage range for VBUS from 2.8V to 20V
- System power supply V5V from 4.0V to 5.5V
- Chip power supply VDD from 2.7V to 5.5V
- VBUS to VCHG Switch
  - 28mΩ (typical) ultra low ON resistance
  - I<sub>SW</sub> maximum 5A continuous current
  - Bidirectional operation: 20V sink switch from VBUS to VCHG with RCP and 6V source switch from VCHG to VBUS with overcurrent limit
  - Adjustable overcurrent limit for source configuration from 400mA to 3.4A by I<sup>2</sup>C-bus interface
- V5V to VBUS switch
  - 38mΩ (typical) ultra low ON resistance
  - I<sub>SW</sub> maximum 3.4A continuous current
- Adjustable overcurrent limit from 400mA to 3.4A by I<sup>2</sup>C-bus interface
- · Integrated high voltage LDO with reverse voltage protection
- Built in slew rate control for all power switches for inrush current limit
- Supports 1MHz Fast Mode Plus I<sup>2</sup>C-bus interface and four different I<sup>2</sup>C slave addresses by ADDR pin
- Safety approvals
  - UL 62368-1, file no. 20181009- E470128



USB PD and Type-C high voltage sink/source combo switch with protection

- IEC 62368-1, file no. DK-77044-UL
- Protection circuitry
  - Over-Temperature Protection
  - Over-Voltage Protection
  - Under-Voltage Lockout
  - Reverse current protection
- Surge protection:
  - IEC61000-4-5 exceeds ±95V on VBUS
  - IEC61000-4-5 exceeds ±100V on VBUS with 4.7uF capacitor
- ESD protection
  - IEC61000-4-2 contact discharge exceeds 8kV on VBUS
  - IEC61000-4-2 air discharge exceeds 15kV on VBUS
  - HBM ANSI/ESDA/JEDEC JS-001 Class 2 exceeds 2kV on all pins
  - CDM ANSI/ESDA/JEDEC JS-002 exceeds 500V
- Operating ambient temperature -40°C to +85°C

# **3** Applications

- Notebook, Ultrabook and Desktop
- USB PD DFP, UFP and DRP
- Tablet and Smart phone

# 4 Ordering information

#### Table 1. Ordering information

Type number	Package			
	Temperature range	Name	Description	Version
NX20P3483AUK	-40 °C to +85 °C	WLCSP42	wafer level chip-scale package; 42 bumps; 2.91 mm x 2.51 mm x 0.525 mm body (backside coating included)	SOT1459-6

#### 4.1 Ordering options

#### Table 2. Ordering options

Type number	Orderable part number	Package	Packing method	Minimum order quantity	Temperature
NX20P3483AUK	NX20P3483AUKZ	WLCSP42	reel dry pack, SMD, 7" Q1 standard product orientation	2000	$T_{amb}$ = -40 °C to +85 °C

# 5 Marking

#### Table 3. Marking

Line	Content	Description
1	Pin 1 dot	Pin 1 dot
	3483AUK	Product identification

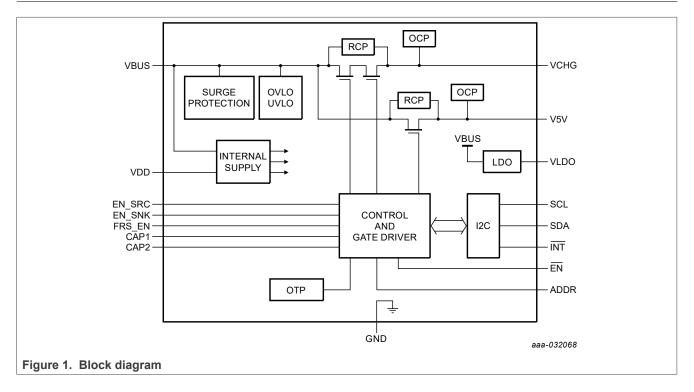
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Table 2 Maulting

#### USB PD and Type-C high voltage sink/source combo switch with protection

Table 3.	Markingcontinued	d	
Line	Content	Description	
2	XXXX	4 digit lot number before dot	
	??	wafer ID	
3	N	wafer fab code	
	t	Identification of assembly site (ASE-K)	
	D	RoHS indicator (Dark green)	
	YWW	Y: Last digits of year code of assembly, WW: week code of assembly	
4	CCC-RRR	ie x-y coordinate	

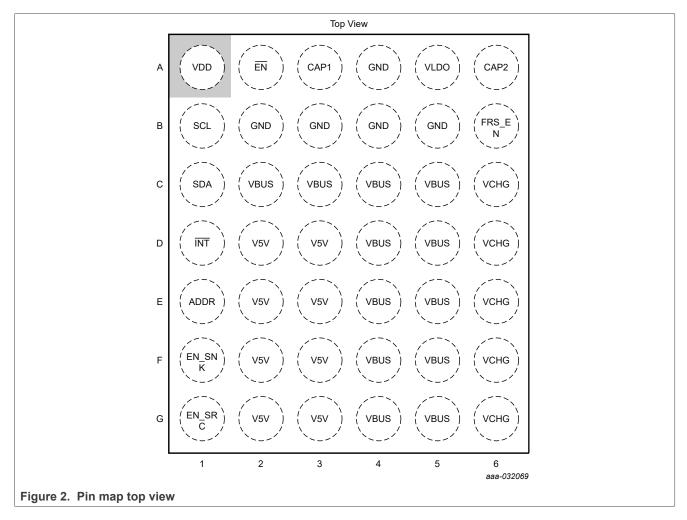
# 6 Functional diagram



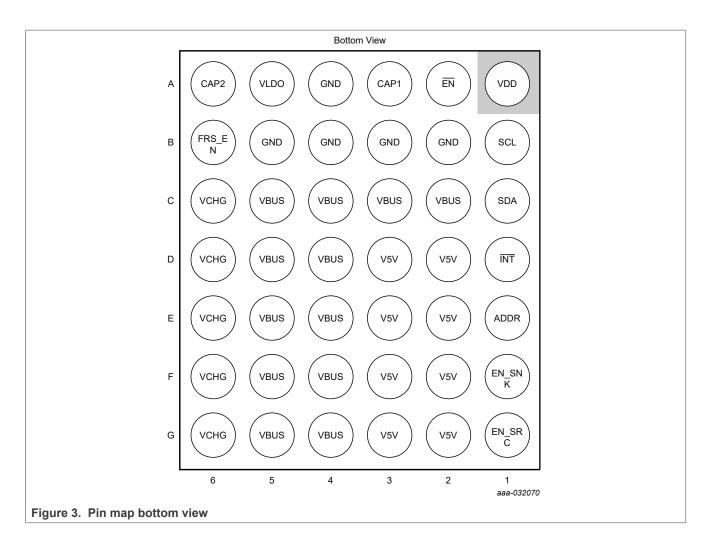
#### USB PD and Type-C high voltage sink/source combo switch with protection

# 7 Pinning information

# 7.1 Pinning







### 7.2 Pin description

#### Table 4. Pin description

Symbol	Pin	Description
VBUS	C2, C3, C4, C5, D4, D5, E4, E5, F4, F5, G4, G5	Power supply pin, Connects to TYPE-C Connector VBUS
VCHG	C6, D6, E6, F6, G6	connects to system charger input for USB PD voltage charging or output.
V5V	D2, E2, F2, G2, D3, E3, F3, G3	Power supply pin, 5V supply for the device and TYPE-C VBUS output
VDD	A1	Chip power supply, connects to system always ON 3.3V power rail or VBAT of 1S battery system
GND	A4, B3, B4, B5, B2	ground (0V)
FRS_EN	B6	Fast role swap enable pin, connects to TCPC fast role swap enable output pin
CAP1	A3	Internal power rail capacitance pin 1
CAP2	A6	Internal power rail capacitance pin 2
SDA	C1	I <sup>2</sup> C Data input/output

Table 4. Fin descriptioncontainded				
Symbol	Pin	Description		
SCL	B1	I <sup>2</sup> C Clock input		
ĪNT	D1	open drain output; I <sup>2</sup> C interrupt and chip alert		
ADDR	E1	I <sup>2</sup> C address select pin		
EN_SNK	F1	Input enable pin for HVSNK power switch		
EN_SRC	G1	Input enable pin for source power switch; the default enable is 5V_SRC power switch. It can be adjusted to enable HV_SRC power switch according to I <sup>2</sup> C register		
VLDO	A5	LDO output pin		
EN	A2	Enable pin for whole chip. Internal pull down resistor integrated		

#### Table 4. Pin description...continued

# 8 Functional description

#### 8.1 Operation modes

NX20P3483AUK can be supplied by VDD power from the system or VBUS power from USB port. Depending upon the power up sequence or availability of VDD and VBUS, the device works in dead battery mode or normal mode. The following sections describe the two modes in detail.

#### 8.1.1 Dead Battery Mode

When VBUS powers up before VDD or VBUS is powered but VDD power is not valid (VDD <VDD UVLO), NX20P3483AUK is forced to be in dead battery mode, regardless of the status of EN, EN\_SNK and EN\_SRC pin. In this mode, NX20P3483AUK automatically closes HV sink path to charge the battery. The VBUS OVLO in dead battery mode is fixed at 6.8V.

NX20P3483AUK only exits from dead battery when the DB\_EXIT bit is set as 1'b1 in register 0Bh by host and VDD is valid (>VDD UVLO). If the DB\_EXIT is set as 1'b1 by host but VDD is less than UVLO, the device stays in dead battery mode and triggers an interrupt to notify host by setting DBEXIT\_ERR in register 04h. In this mode, NX20P3483AUK will not support source role and fast role swap.

In dead battery mode, the system can read and write to I<sup>2</sup>C register, but NX20P3483AUK will not take any action to respond to the control commands except for DB\_EXIT bit. When NX20P3483AUK exits from dead battery mode, the I<sup>2</sup>C register is reset to the default value except for interrupt registers, and the device is controlled by EN\_SNK and EN\_SRC. If the HV sink path needs to be kept closed for charging after exiting dead battery mode, the EN\_SNK pin should be asserted to HIGH 50us before system sets DB\_EXIT bit as "1".

After NX20P3483AUK exits from dead battery mode and VDD > VDD UVLO, if system sets DB\_EXIT bit to "0" in register 0Bh; NX20P3483AUK will not respond to it and keeps the current status.

While in normal mode, if VDD power is down and VDD < VDD ULVO, the device enters dead battery mode as well and resets DB\_EXIT to "0".

#### 8.1.2 Normal Modes

When VDD powers up before VBUS, VDD is powered but VBUS power is not valid (VBUS < VBUS UVLO) or when NX20P3483AUK exits from dead battery mode, the device works in normal mode. The normal modes are controlled by EN, EN\_SNK or EN\_SRC pins as shown in <u>Table 5</u>.

EN	EN_SNK	EN_SRC	Operation mode
0	0	0	Standby mode
0	0	1	Source Mode: default enable 5V_SRC power switch. It can be configured to enable HV_SRC power switch through $I^2C$ register
0	1	0	HV Sink Mode: enable HV_SNK power switch
0	1	1	Forbidden, an error interrupt will be reported to system. The device keeps at the current status
1	x	x	Shutdown Mode

#### Table 5. Operation Modes

#### 8.1.2.1 HV Sink Mode

In normal mode, when EN and EN\_SRC are LOW and EN\_SNK is HIGH, NX20P3483AUK works in HV Sink mode. It turns on HV Sink path and takes power from VBUS to VCHG.

#### 8.1.2.2 Source Mode

In normal mode, when EN and EN\_SNK are LOW and EN\_SRC is HIGH, NX20P3483AUK works in Source mode. By default it turns on 5V Source path and supplies 5V power from V5V to VBUS.

The device supports fast role swap through the 5V Source path. If FRS\_EN is set HIGH or FRS\_AT bit is 1'b1 in register 0Bh, V5V is valid and EN\_SRC=1, 5V source path is enabled with fast turn on feature. NX20P3483AUK resumes the VBUS to vSafe5V in 100us.

NX20P3483AUK can be configured to VCHG-VBUS Source path through I<sup>2</sup>C-bus interface. When SRC\_SEL bit of register 02h is 1'b1, the EN\_SRC=HIGH enables VCHG-VBUS Source path power switch, which supplies voltage up to 6V from VCHG to VBUS by reverse boost of battery charger.

#### 8.1.2.3 Standby mode

In normal mode, when  $\overline{EN}$ ,  $EN_SNK$  and  $EN_SRC$  are LOW, NX20P3483AUK is in standby mode. In this mode, most of internal circuits are turned off to save power. In order to react to system requests, the I<sup>2</sup>C circuits are idle.

#### 8.1.2.4 Shutdown mode

In normal mode, when EN is HIGH, NX20P3483AUK is in shutdown mode. It is a low power mode to save system power consumption.

#### 8.2 VBUS-VCHG Switch

The VBUS-VCHG path is a bidirectional high voltage capable switch. It can be configured to HV sink switch or source switch by I<sup>2</sup>C-bus interface based on system requirement.

#### 8.2.1 VBUS-VCHG HV Sink Mode

When EN\_SNK is HIGH, VBUS-VCHG path works as a HV sink switch. It acts as a charging path to sink current from VBUS to VCHG. In this mode, the switch has adjustable overvoltage protection, reverse current protection from VCHG to VBUS and short circuit protection.

Overvoltage protection

The overvoltage protection trip level can be programed by register 08h as shown in <u>Table 6</u>. Before the system sets NX20P3483AUK to HV Sink mode, the OVLO threshold needs to be set if the threshold is not the reset default value, which is 6.8V.

Table 6. OVLO threshold setting by I <sup>2</sup> C re	register
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Register Value OVP[2:0]	OVLO Threshold value
000	6V
001	6.8V (default)
010	10V
011	11.5V
100	14V
101	17V
110	23V
111	NA

When NX20P3483AUK is in HV sink mode, the over-voltage lockout (OVLO) circuit disables the VBUS-VCHG power MOSFET. The OV\_HVSNK in register 05h is set as "1" and an interrupt will be issued to notify the host. Once VBUS drops below  $V_{OVLO}$  and no other protection circuit is active, the power MOSFET resumes operation.

Reverse current protection

The RCP circuit is integrated to prevent leakage from system to port. When the VCHG voltage exceeds the VBUS voltage by 10mV, the device will shutdown the power FET after 4ms de-glitch time. When VCHG voltage exceeds the VBUS voltage by 60mV, the device will shutdown the FET immediately without any de-glitch time. If RCP state is detected before enabling the power FET, the power FET will be kept in OFF state.

Short circuit protection

The short circuit protection is integrated for this mode. When MOSFET is fully turned on and the current through it exceeds 10A, it turns off MOSFET to protect the device and system. An interrupt will be issued when short circuit protection is triggered by setting SC\_HVSNK as "1" in register 05h. Once the short circuit condition is removed and no other protection circuit is active, the state of the MOSFET is controlled by I<sup>2</sup>C register bit again.

#### 8.2.2 VCHG-VBUS HV Source Mode

When EN\_SRC is HIGH and SRC\_SEL bit is 1'b1 in register 02h, VCHG-VBUS path works as a source switch. It is a source path to supply external accessory up to 6V. In this mode, the switch has adjustable overcurrent limit, reverse current protection from VBUS to VCHG and short circuit protection. The VBUS is also protected with overvoltage protection circuit and the threshold can be adjusted according to <u>Table 6</u>. Before the system sets NX20P3483AUK to HV Source mode, the OVLO threshold needs to be set.

· Adjustable overcurrent limit

The HV source mode offers overcurrent limit function. If the device senses  $I_{SW}$  exceeds  $I_{OCP}$  when enabled, OCP is triggered. It limits the output current to  $I_{OCP}$ , and an interrupt is issued to notify host by setting OC\_HVSRC as "1" in register 05h. As a consequence, limiting the output current generates much higher power dissipation on the device, which could lead to over temperature protection (see <u>Section 8.7</u>).

The  $I_{OCP}$  can be adjusted by the register 09h according to <u>Table 7</u> below.

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Register Value HVOCP[3:0]	HV Source Switch OCP Threshold Fine Tune value
0000	400mA
0001	600mA
0010	800mA
0011	1000mA
0100	1200mA
0101	1400mA
0110	1600mA (Default)
0111	1800mA
1000	2000mA
1001	2200mA
1010	2400mA
1011	2600mA
1100	2800mA
1101	3000mA
1110	3200mA
1111	3400mA

					2	
Table 7	LIV Courco	switch O(	P threshold	cotting	by IfC	rogistor
I able 1.	nv Source	SWILCH OV	>F 1116311010	Setting	DYIC	register

Reverse current protection

The RCP circuit is integrated to prevent any reverse drive from VBUS to system. When the VBUS voltage exceeds the VCHG voltage by 15mV, the device will shutdown the power FET after 4ms de-glitch time; when VBUS voltage exceeds the VCHG voltage by 100mV, the device will shutdown the FET immediately without any de-glitch time. If RCP state is detected before enabling the power FET, the power FET will be kept in OFF state.

Short circuit protection

The short circuit protection is integrated for this mode. When MOSFET is fully turned on and the current through it exceeds 7A, it turns off the MOSFET to protect the device and system. An interrupt will be issued when short circuit protection is triggered by setting SC\_HVSRC as "1" in register 05h. Once the short circuit condition is removed and no other protection circuit is active, the state of the MOSFET is controlled by I<sup>2</sup>C register bit again.

### 8.3 V5V-VBUS 5V Source Switch

When EN\_SRC is HIGH and SRC\_SEL bit is 1'b0 in register 02h, the V5V-VBUS path is turned on and supplies the external accessary for 5V. The switch offers adjustable overcurrent limit, "ideal diode" feature, short circuit protection and overvoltage protection with fixed 6V OVLO trip level.

Adjustable overcurrent limit

The 5V source switch has overcurrent limit feature. If the device senses  $I_{SW}$  exceeds  $I_{OCP}$  when enabled, OCP is triggered. It limits the output current to  $I_{OCP}$ , an interrupt is issued to notify host by setting OC\_5VSRC as "1". As a consequence, limiting the output current generates much higher power dissipation on the device, which could lead to over temperature protection (see <u>Section 8.7</u>).

The  $I_{OCP}$  can be adjusted by the register 0Ah according to <u>Table 8</u> below.

Register Value 5VOCP[3:0]	5V Source Switch OCP Threshold Fine Tune value
0000	400mA
0001	600mA
0010	800mA
0011	1000mA
0100	1200mA
0101	1400mA
0110	1600mA (Default)
0111	1800mA
1000	2000mA
1001	2200mA
1010	2400mA
1011	2600mA
1100	2800mA
1101	3000mA
1110	3200mA
1111	3400mA

Table 8.	5V Source	switch OCF	threshold	setting by	l <sup>2</sup> C register
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#### • "Ideal diode" feature

The 5V source path integrates "ideal diode" feature. It operates like an ideal diode; whenever the VBUS voltage exceeds V5V voltage, the "ideal diode" feature turns off the path and prevents any reverse current from VBUS to V5V node. It protects the V5V lift by the reverse current when VBUS has a hot plug in the following conditions and limits the V5V voltage lift <400mV:

- VBUS<24V, plug in when 5V SRC switch is on
- $C_{V5V}$  is in the range of 47uF 100uF
- C<sub>BUS</sub> is in the range of 4.7uF 10uF

If the VBUS,  $C_{V5V}$ , and  $C_{BUS}$  are not in the range or conditions, they may have more reverse current and the VIN voltage lift depends on the conditions.

Short circuit protection

The short circuit protection is integrated for 5V source path. When MOSFET is fully turned on and the current through it exceeds 7A, it turns off MOSFET to protect device and system. An interrupt will be issued when short circuit protection is triggered by setting OC\_5VSRC as "1" in register 04h. Once the short circuit condition is removed and no other protection circuit is active, the state of the MOSFET is controlled by I<sup>2</sup>C register bit again.

In the customer specific application case, the short circuit protection ensures the V5V voltage stays above 4.65V at the following short circuit testing.

- C<sub>IN</sub> = 47μF, VBUS short to GND directly by a metal tweezer; the short resistor to ground is typically 40mΩ
- VIN connected to customer specified DC-DC

### 8.4 LDO Output

When NX20P3483AUK is working at dead battery mode or HV sink mode, the integrated LDO is enabled and regulates the output voltage to 3.3V typically at VBUS>5V. It provides power to the downstream circuits when

it is in dead battery mode or there is no battery. The current capability of the LDO is up to 100mA. The output capacitance of the LDO is 4.7µF, which should be connected as close as possible to VLDO pin.

When VBUS voltage drops below VLDO specified voltage in <u>Table 26</u>, the LDO is not turned off immediately but follows VBUS voltage drop and turns off when VBUS  $< V_{UVLO}$ .

When over temperature protection is triggered, the LDO is turned off by over temperature protection circuit. It can be turned off by LDO\_SD bit in register 0Bh also for power saving.

#### 8.5 Under-voltage lock-out

When VBUS and V5V exceeds UVLO threshold voltage, the device is in the modes defined in Table 5.

#### 8.6 VBUS Discharge

In USB PD specifications, the VBUS voltage is required to be discharged to Vsafe5v and Vsafe0v when VBUS is detached or Hard Reset occurs. NX20P3483AUK integrates VBUS discharge circuit and is controlled by VBUSDIS\_EN in register 0Bh. The VBUS discharge function can be shut down by EN pin.

#### 8.7 Over-temperature protection

When NX20P3483AUK is conducting and the device temperature exceeds 140 °C, the over-temperature protection (OTP) circuit disables all the power switches and an interrupt will be sent to the host by setting OTP bit as "1" in register 04h. The power switches cannot be re-enabled in over-temperature protection. Once the device temperature decreases to below 120 °C, the device returns to normal operation.

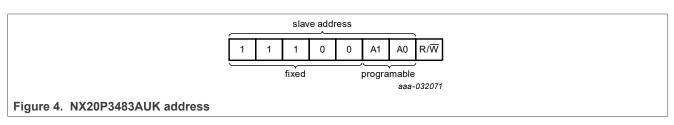
### 8.8 I<sup>2</sup>C Device Address

Following a START condition, the bus master must send the target slave address followed by a read (R/W = 1) or write (R/W = 0) operation bit. The slave address of the NX20P3483AUK is shown in <u>Figure 4</u>. Slave address pin ADDR chooses one of four slave addresses. <u>Table 9</u> shows all four slave addresses by connecting the ADDR pin to SCL, SDA, GND, or VDD.

ADDR	I	Device family	y high-order	Variable of ad	-	Address		
	A6	A5	A4	A3	A2	A1	A0	
SCL	1	1	1	0	0	0	0	E0h
SDA	1	1	1	0	0	0	1	E2h
GND	1	1	1	0	0	1	0	E4h
VDD	1	1	1	0	0	1	1	E6h

Table 9. NX20P3483AUK address map

The last bit of the first byte defines the reading from or writing to the NX20P3483AUK. When setting to logic 1 a read is selected, while logic 0 selects a write operation.



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### 8.9 Register Map

The registers of NX20P3483AUK are listed in Table 10.

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#### USB PD and Type-C high voltage sink/source combo switch with protection

#### Table 10. NX20P3483AUK Register map

Addr (xxh)	Name	Туре	Reset Value	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
00h	Device ID (reserved)	R	-			Vendor number				Revision number	
01h	Device Status	R	00h						Mode2	Mode1	Mode0
02h	Switch Control	R/W	00h	SRC_SEL	-	-	-	-	-	-	-
03h	Switch Status	R	00h	-	-	-	-	-	5VSRC_STS	HVSRC_STS	HVSNK_STS
04h	Interrupt1	C/R	00h	DBEXIT_ERR	-	-	OV_5VSRC	RCP_5VSRC	SC_5VSRC	OC_5VSRC	OTP
05h	Interrupt2	C/R	00h	EN_ERR	RCP_HVSNK	SC_HVSNK	OV_HVSNK	RCP_HVSRC	SC_HVSRC	OC_HVSRC	OV_HVSRC
06h	Interrupt1 Mask	R/W	00h	DBEXIT_ ERR_MASK	-	-	OV_5VSRC_ MASK	RCP_5 VSRC_MASK	SC_5VSRC_ MASK	OC_5VSRC_ MASK	OTP_MASK
07h	Interrupt2 Mask	R/W	00h	EN_ERR_ MASK	RCP_ HVSNK_ MASK	SC_HVSNK_ MASK	OV_HVSNK_ MASK	RCP_ HVSRC_ MASK	SC_HVSRC_ MASK	OC_HVSRC_ MASK	OV_HVSRC_ MASK
08h	OVLO Threshold	R/W	01h	-	-	-	-	-	OVP2	OVP1	OVP0
09h	HV SRC OCP Threshold	R/W	0Bh	-	-	-	-	HVOCP3	HVOCP2	HVOCP1	HVOCP0
0Ah	5V SRC OCP Threshold	R/W	0Bh	-	-	-	-	5VOCP3	5VOCP2	5VOCP1	5VOCP0
0Bh	Device Control	R/W	00h	-	-	-	-	FRS_AT	DB_EXIT	VBUSDIS_EN	LDO_SD

#### 8.9.1 Device ID Register (Address 00h)

Table 11. Device ID Register

Bit	Name	Туре	Reset Value	Description
7:3	Vendor ID	R	00001	NXP Vendor ID 00001
2:0	Version ID	R	010	Device revision number revision 010

#### 8.9.2 Device Status Register (Address 01h)

Table 12. Device Status Register

Bit	Name	Туре	Reset Value	Description
7:3	Reserved	R	00h	default 00h
2:0	Mode[2:0]	R	04h	Device mode status according to <u>Section 8.1</u>
				000 = Dead battery mode
				001=HV SNK mode
				010 = 5V SRC mode
				011 = HV SRC mode
				100 = Standby mode

#### 8.9.3 Switch Control Register (Address 02h)

This register controls the EN\_SRC turn on 5V SRC switch or HV SRC switch. It is required to set SRC\_SEL bit before assert EN\_SRC pin. The default value is 0h to turn on 5V SRC switch.

#### Table 13. Switch control Register

Bit	Name	Туре	Reset Value	Description
7	SRC_SEL	R/W	0h	0h = 5V SRC for source path
				1h = HV SRC for source path
6:0	Reserved	R/W	0h	Default 0h

#### 8.9.4 Switch Status Register (Address 03h)

This register reports the state of all the power switches of NX20P3483AUK.

Bit	Name	Туре	Reset Value	Description	
7:3	Reserved	R	0h	Default 0h	
2	5VSRC_STS	R	0h	0h = 5V source switch is off	
				1h = 5V source switch is on	
1	HVSRC_STS	R	0h	0h = HV source switch is off	
				1h = HV source switch is on	
0	HVSNK_STS	R	0h	0h = HV sink switch is off	
				1h = HV sink switch is on	

#### 8.9.5 Interrupt1 Register (Address 04h)

The Interrupt1 register contains flags indicating error flags, 5V source switch fault conditions and a chip level over temperature flag. An event will be latched and only the first occurrence triggers an interrupt (if not masked). Reoccurring events will not change the flags' status or trigger an additional interrupt. The event registers are automatically cleared by reading.

Bit	Name	Туре	Reset Value	Description
7	DBEXIT_ERR	C/R	0h	Exit dead battery error, please refer to Section 8.1.2
				0: No exit dead battery error
				1: Exit dead battery error occurs
6:5	Reserved	C/R	0h	0h = Default
4	OV_5VSRC	C/R	0h	5V Source switch overvoltage protection
				0: No overvoltage fault
				1: overvoltage fault triggered
3	RCP_5VSRC	C/R	0h	5V Source switch RCP
				0: No reverse current fault
				1: Reverse current fault triggered
2	SC_5VSRC	C/R	C/R 0h	5V Source switch short circuit protection
				0: No short circuit fault
				1: Short circuit protection fault triggered
1	OC_5VSRC	C/R	0h	5V Source switch overcurrent limit
				0: No overcurrent fault
				1: over circuit limit triggered
0	OTP	C/R	0h	Chip Over temperature protection
				0: No over temperature fault
				1: over temperature protection fault triggered

#### Table 15. Interrupt1 Register

#### 8.9.6 Interrupt2 Register (Address 05h)

The Interrupt2 register contains flags indicating HV source and HV sink switch fault conditions. An event will be latched and only the first occurrence triggers an interrupt (if not masked). Reoccurring events will not change the flags' status or trigger an additional interrupt. The event registers are automatically cleared by reading.

Bit	Name	Туре	Reset Value	Description
7	EN_ERR	C/R	0h	EN_SNK and EN_SRC both high error fault
				0: EN_SNK and EN_SRC are not both high
				1: EN_SNK and EN_SRC are both high
6	RCP_HVSNK	C/R	0h	HV Sink switch RCP
				0: No reverse current fault
				1: Reverse current fault triggered

Table 16. Interrupt2 Register

#### USB PD and Type-C high voltage sink/source combo switch with protection

HV Source switch overvoltage protection

0: No overvoltage fault

1: Overvoltage fault triggered

Table 1	16. Interrupt2 Registerco	ntinued		1
Bit	Name	Туре	Reset Value	Description
5	SC_HVSNK	C/R	0h	HV Sink switch short circuit protection
				0: No short circuit fault
				1: Short circuit protection fault triggered
4	OV_HVSNK	C/R	0h	HV Sink switch overvoltage protection
				0: No overvoltage fault
				1: Overvoltage fault triggered
3	RCP_HVSRC	C/R	0h	HV Source switch RCP
				0: No reverse current fault
				1: Reverse current fault triggered
2	SC_HVSRC	C/R	0h	HV Source switch short circuit protection
				0: No short circuit fault
				1: Short circuit protection fault triggered
1	OC_HVSRC	C/R	0h	HV Source switch overcurrent limit
				0: No overcurrent fault
				1: overcurrent limit triggered

0h

C/R

#### Т

#### 8.9.7 Interrupt1 Mask Register (Address 06h)

The Interrupt1 Mask register enables the masking (disabling) of the different available interrupt signals of register Interrupt1.

Table 17. Interrupt1 Register

OV\_HVSRC

0

Bit	Name	Туре	Reset Value	Description
7	DBEXIT_ERR_MASK C/R 0h	0h	Dead battery exit error interrupt mask	
				0: Can trigger the interrupt
				1: Cannot trigger the interrupt
6:5	Reserved	C/R	0h	0h = Default
4	OV_5VSRC_MASK	C/R	/R 0h	5V Source switch overvoltage protection interrupt mask
				0: Can trigger the interrupt
				1: Cannot trigger the interrupt
3	RCP_5VSRC_MASK	C/R	0h	5V Source switch RCP interrupt mask
				0: Can trigger the interrupt
				1: Cannot trigger the interrupt
2	SC_5VSRC_MASK	C/R	0h	5V Source switch short circuit protection interrupt mask
				0: Can trigger the interrupt

Table 17. Interrupt1 Register...continued

Bit	Name	Туре	Reset Value	Description
				1: Cannot trigger the interrupt
1	OC_5VSRC_MASK	C/R	C/R 0h f	5V Source switch overcurrent protection interrupt mask
				0: Can trigger the interrupt
			1: Cannot trigger the interrupt	
0	OTP_MASK	C/R	0h	Chip Over temperature protection interrupt mask
			0: Can trigger the interrupt	
				1: Cannot trigger the interrupt

#### 8.9.8 Interrupt2 Mask Register (Address 07h)

The Interrupt2 Mask register enables the masking (disabling) of the different available interrupt signals of register Interrupt2.

Table	18	Interrupt2	Register
Table	10.	menuple	Register

Bit	Name	Туре	<b>Reset Value</b>	Description
7	EN_ERR_MASK	C/R	0h	EN_SNK and EN_SNK both HIGH error interrupt mask
				0: Can trigger the interrupt
				1: Cannot trigger the interrupt
6	RCP_HVSNK_MASK	C/R	0h	HV Sink switch RCP interrupt mask
				0: Can trigger the interrupt
				1: Cannot trigger the interrupt
5	SC_HVSNK_MASK	C/R	0h	HV Sink switch short circuit protection interrupt mask
				0: Can trigger the interrupt
				1: Cannot trigger the interrupt
4	OV_HVSNK_MASK	C/R	0h	HV Sink switch overvoltage protection interrupt mask
				0: Can trigger the interrupt
				1: Cannot trigger the interrupt
3	RCP_HVSRC_MASK	C/R	0h	HV Source switch RCP interrupt mask
				0: Can trigger the interrupt
				1: Cannot trigger the interrupt
2	SC_HVSRC_MASK	C/R	0h	HV Source switch short circuit protection interrupt mask
				0: Can trigger the interrupt
				1: Cannot trigger the interrupt
1	OC_HVSRC_MASK	C/R	0h	HV Source switch overcurrent protection interrupt mask
				0: Can trigger the interrupt
				1: Cannot trigger the interrupt
0	OV_HVSRC_MASK	C/R	0h	HV Source switch overvoltage protection interrupt mask
				0: Can trigger the interrupt

Product data sheet

#### Table 18. Interrupt2 Register...continued

Bit	Name	Туре	Reset Value	Description
				1: Cannot trigger the interrupt

#### 8.9.9 OVLO threshold Register (Address 08h)

This is the register to set the OVLO threshold, please refer to Section 8.2.1.

#### Table 19. OVLO threshold Register

Bit	Name	Туре	Reset Value	Description
7:3	Reserved	R/W	0h	0h=default
3:0	OVP[2:0]	R/W	01h	OVLO threshold setting bits. Reset default OVLO threshold is 6.8V.

#### 8.9.10 HV source switch OCP threshold Register (Address 09h)

This is the register to set the HV source switch OCP trip level threshold, please refer to Section 8.2.2.

Table 20.	nv source switch OCP thresh	olu regis	lei	
Bit	Name	Туре	Reset Value	Description
7:4	Reserved	R/W	0h	0h=default
3:0	HVOCP[3:0]	R/W	06h	HV source switch setting bits

#### Table 20. HV source switch OCP threshold register

#### 8.9.11 5V source switch OCP threshold Register (Address 0Ah)

This is the register to set the 5V source switch OCP trip level threshold, please refer to <u>Section 8.3</u>.

Bit	Name	Туре	Reset Value	Description
7:4	Reserved	R/W	0h	0h=default
3:0	5VOCP[3:0]	R/W	06h	5V source switch setting bits

#### 8.9.12 Device control Register (Address 0Bh)

The register controls device status for exiting dead battery mode, enabling VBUS discharge circuit and shutting down LDO.

 Table 22. Device control Register

Bit	Name	Туре	Reset Value	Description
7:4	Reserved	R/W	0h	0h=default
3	FRS_AT	R/W	0h	Activate fast role swap
				0: Fast role swap capability is not activated
				1: Fast role swap capability is activated
2	DB_EXIT	R/W	0h	Exit dead battery mode
				0: keeps in dead battery mode
				1: Exit dead battery mode

	ible ZZ. Device control Register containing					
Bit	Name	Туре	Reset Value	Description		
1	VBUSDIS_EN	R/W	0h VBUS discharge enable bit			
				0: VBUS discharge circuit disabled		
				1: VBUS discharge circuit enabled		
0	LDO_SD	R/W	0h	LDO Shut down control bit		
				0: LDO is enabled		
				1: LDO is shutdown		

 Table 22. Device control Register...continued

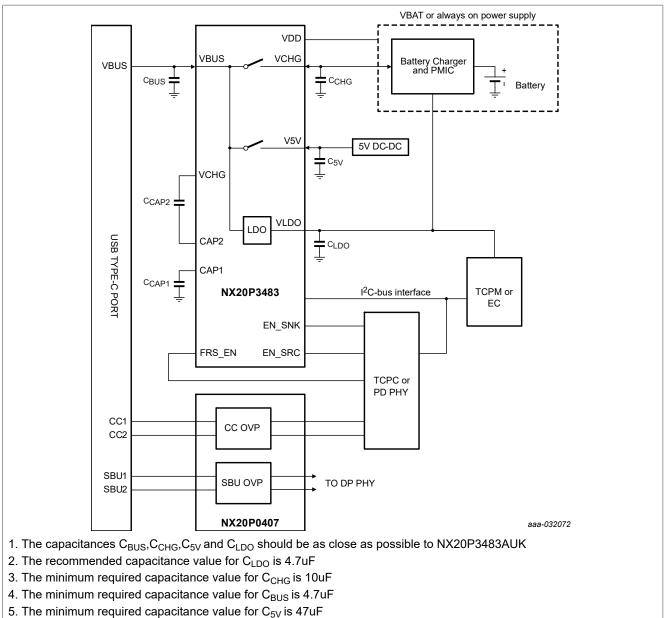
# 9 Application diagram

The NX20P3483AUK is typically used on a USB PD port in a portable, battery operated device. It provides HV sink path for charging from VBUS to VCHG, 5V source path for Type C 5V output to accessory and HV source path for USB PD output to accessory. Besides the power paths, a 3.3V LDO is integrated to supply TCPM or EC in dead battery operation. The device can be controlled by I<sup>2</sup>C-bus interface by TCPM or system chip.

The device is fully compliant with normal USB PD PHY and TCPC+TCPM structure.

NX20P3483AUK Product data sheet

USB PD and Type-C high voltage sink/source combo switch with protection



6.  $C_{CAP1}$  and  $C_{CAP2}$  are the capacitors for internal power rail, the recommend  $C_{CAP1}$  is 1nF 16V capacitor and  $C_{CAP2}$  is 10nF 25V capacitor

Figure 5. NX20P3483AUK application diagram

#### **Limiting values** 10

#### Table 23. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		Min	Мах	Unit
VI	input voltage	VBUS; VCHG		-0.5	+29	V
		V5V; VDD		-0.5	+6.0	V
		EN; SCL; SDA; FRS_EN	[1]	-0.5	+6.0	V
		EN_SNK; EN_SRC	[1]	-0.5	+29	V
Vo	output voltage	INT; VLDO		-0.5	+6.0	V
		CAP1		-0.5	+12	V
		CAP2	[2]	-0.5	+20	V
I <sub>IK</sub>	input clamping current	EN; V <sub>1</sub> < -0.5 V;		-50	-	mA
I <sub>SW</sub>	High voltage Power switch continuous current	V <sub>SW</sub> > -0.5 V		-	5	A
	5V power switch continuous current	V <sub>SW</sub> > -0.5 V		-	3.5	A
T <sub>j(max)</sub>	maximum junction temperature			-40	+125	°C
T <sub>stg</sub>	storage temperature			-65	+150	°C
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> =25°C	[3]	-	2.02	W

The minimum input voltage rating may be exceeded if the input current rating is observed. [1]

The minimum input voltage rating may be exceeded in the input current rating is observed. Though the CAP2 maximum rating is specified as 20V, CAP2 is a floating source refer to VCHG. If CAP2 is forced by an external power source, the maximum difference between VCHG and CAP2 should be less than 6V. [2]

The (absolute) maximum power dissipation depends on the junction temperature  $T_j$ . Higher power dissipation is allowed in conjunction with lower ambient temperatures. The conditions to determine the specified values are  $T_{amb}$  = 25 °C and the use of a two layer PCB. [3]

# 11 Recommended operating conditions

Symbol	Parameter	Conditions	Min	Max	Unit
VI	input voltage	VBUS;	2.8	20	V
		VCHG; as voltage input of source switch from VCHG to VBUS	4.0	6.0	V
		VDD	2.7	5.5	V
		V5V	4.0	5.5	V
		EN; SCL; SDA; FRS_EN	0	5.5	V
		EN_SNK; EN_SRC	0	5.5	V
Vo	Output voltage	VLDO; INT	0	5.5	V
		CAP1	0	10	V
		CAP2	VCHG-5V	VCHG	V
I <sub>SW</sub>	High voltage switch current	$T_{amb}$ = -40 °C to +85 °C	0	5	А
	5V source switch current	$T_{amb}$ = -40 °C to +85 °C	0	3	A
T <sub>amb</sub>	ambient temperature		-40	+85	°C

#### Table 24. Recommended operating conditions

### **12** Thermal characteristics

#### Table 25. Thermal characteristics

Symbol	Parameter	Conditions		Тур	Unit
R <sub>th(j-a)</sub>	thermal resistance from junction to ambient		[1]	49.4	K/W

[1] R<sub>th(j-a)</sub> is dependent upon board layout. To minimize R<sub>th(j-a)</sub>, ensure all pins have a solid connection to larger copper layer areas. In multi-layer PCBs, the second layer should be used to create a large heat spreader area below the device. Avoid using solder-stop varnish under the device.

# 13 Static characteristics

#### Table 26. Static characteristics

At recommended operating conditions and VDD=3.3V; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	T <sub>amb</sub> = 25 °C			T <sub>amb</sub> = - +85 °C	Unit	
			Min	Тур	Мах	Min	Мах	
General Specific	cations	·						
VIH	HIGH-level input voltage	EN, EN_SNK, EN_SRC, FRS_EN pins;	1.2	-	-	1.2	-	V
V <sub>IL</sub>	LOW-level input voltage	EN, EN_SNK, EN_SRC, FRS_EN pins;	-	-	0.4	-	0.4	V
I <sub>I</sub>	Input pin leakage	EN, FRS_EN pins; V <sub>I</sub> =0V	-	0.1	-	-1	1	μA
	current	EN, FRS_EN pins; V <sub>I</sub> =5V	-	5	-	3	8	μA
		EN_SNK, EN_SRC pins; V <sub>I</sub> =0V	-	0.1	-	-1	1	μA
		EN_SNK, EN_SRC pins; V <sub>I</sub> =5V	-	5	-	3	8	μA

### USB PD and Type-C high voltage sink/source combo switch with protection

#### Table 26. Static characteristics...continued

At recommended operating conditions and VDD=3.3V; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	T,	<sub>amb</sub> = 25	°C	T <sub>amb</sub> = - +85 °C	Unit	
			Min	Тур	Мах	Min	Max	1
CI	input capacitance	EN, FRS_EN pin; V <sub>I(VDD)</sub> = 5V	-	4.5	-	-	-	pF
		$\label{eq:entropy} \begin{array}{l} EN\_SNK,  EN\_SRC  pins; \\ V_{I(VDD)} = 5V \end{array}$	-	8	-	-	-	pF
R <sub>pd</sub>	pull-down resistance	EN pin;	-	1	-	-	-	MΩ
I <sub>q_VDD_HVSINK</sub>	VDD quiescent current	EN = 0 V; HV sink mode, VDD=3.3V, VBUS=5V	-	1	-	-	5	μA
		EN = 0 V; HV sink mode, VDD=5V, VBUS=5V	-	155	-	-	225	μA
I <sub>q_VBUS_HVSINK</sub>	VBUS quiescent current	EN = 0 V; HV sink mode, VDD=3.3V, VBUS=5V	-	205	-	-	300	μA
		EN = 0 V; HV sink mode, VDD=5V, VBUS=5V	-	50	-	-	75	μA
Iq_VDD_HVSRC	VDD quiescent current	$\overline{EN}$ = 0 V; HV source mode, VDD=3.3V, VCHG=5V, I <sub>LOAD</sub> = 0A	-	1	-	-	5	μA
		EN = 0 V; HV source mode, VDD=5V, VCHG=5V, I <sub>LOAD</sub> = 0A	-	210	-	-	275	μA
I <sub>q_VBUS_HVSRC</sub>	VCHG quiescent current	EN = 0 V; HV source mode, VDD=3.3V, VCHG=5V, I <sub>LOAD</sub> = 0A	-	360	-	-	500	μA
		EN = 0 V; HV source mode, VDD=5V, VCHG=5V, I <sub>LOAD</sub> = 0A	-	150	-	-	225	μA
Iq_VDD_5VSRC	VDD quiescent current	EN = 0 V; HV source mode, VDD=3.3V, V5V=5V, I <sub>LOAD</sub> = 0A	-	1	-	-	5	μA
		EN = 0 V; HV source mode, VDD=5V, V5V=5V, I <sub>LOAD</sub> = 0A	-	130	-	-	190	μA
Iq_V5V_5VSRC	V5V quiescent current	EN = 0 V; HV source mode, VDD=3.3V, V5V=5V, I <sub>LOAD</sub> = 0A	-	1.25	-	-	1.62	mA
		EN = 0 V; HV source mode, VDD=5V, V5V=5V, I <sub>LOAD</sub> = 0A	-	1.12	-	-	1.5	mA
I <sub>q_standby</sub>	VDD quiescent	EN = 0V; No switch in operation, VDD=3.3V	-	7.5	-	-	24	μA
		EN = 0V; No switch in operation, VDD=5V	-	8.5	-	-	25	μA
I <sub>q_shutdown</sub>	VDD quiescent	<u>EN</u> = 5V;	-	1.8	-	-	4	μA
V <sub>VBUS_UVLO</sub>	under-voltage	VBUS Rising; EN = 0 V	-	2.6	-	2.45	2.75	V
	lockout release voltage	VBUS Falling;	-	2.5	-			V
V <sub>VDD_UVLO</sub>	under-voltage	VDD Rising; EN = 0 V	-	2.5	-	2.35	2.65	V
	lockout release voltage	VDD Falling;	-	2.4	-			V

#### USB PD and Type-C high voltage sink/source combo switch with protection

#### Table 26. Static characteristics...continued

At recommended operating conditions and VDD=3.3V; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	T,	amb = 25	°C	T <sub>amb</sub> = - +85 °C	Unit	
			Min	Тур	Мах	Min	Мах	
V <sub>V5V_UVLO</sub>	under-voltage	V5V Rising; EN = 0 V	-	3.6	-	3.4	3.8	V
	lockout release voltage	V5V Falling;	-	3.5	-			V
V <sub>VHCG_UVLO</sub>	under-voltage	VCHG Rising; EN = 0 V	-	3.6	-	3.4	3.8	V
	lockout release voltage	VCHG Falling;	-	3.5	-			V
V <sub>VLDO</sub>	LDO output voltage	VBUS=5V; I <sub>LOAD</sub> =100mA	-	3.3	-	3.0	3.6	V
HV SNK Switch S	pecifications							
V <sub>OVLO_HVSNK_ACC</sub>	Overvoltage lockout voltage accuracy	VBUS Rising; $\overline{EN} = 0$ V; For all OVLO level set by <u>Table 6</u>	-5	-	5	-5	5	%
V <sub>hys(OVLO)</sub>	Overvoltage lockout hysteresis voltage	VBUS Falling; EN = 0 V; For all OVLO level set by <u>Table 6</u>	-	2	-	1	3	%
V <sub>RCP_HVSNK</sub>	HV SNK RCP trig level	$V_{\text{RCP}_{\text{HVSNK}}} = V_{(\text{VCHG})} - V_{(\text{VBUS})}$	-	10	-	6	14	mV
V <sub>RCPS_HVSNK</sub>	HV SNK Severe RCP trig level	$V_{\text{RCP}_{\text{HVSNK}}} = V_{(\text{VCHG})} - V_{(\text{VBUS})}$	-	60	-	40	80	mV
I <sub>S(OFF)_HVSNK</sub>	VBUS OFF state leakage	HV SNK Switch OFF; VBUS=5V	-	5	-	-	10	μA
		HV SNK Switch OFF; VBUS=20V	-	15	-	-	30	μA
	VCHG OFF state leakage	HV SNK Switch OFF; VCHG=5V	-	1	-	-	5	μA
		HV SNK Switch OFF; VCHG=20V	-	4	-	-	16	μA
I <sub>S(ON)_HVSNK</sub>	RCP Leakage current	EN = 0 V; HVSNK switch is enabled; VCHG=5V; VBUS=0V	-	1	-	-	5	μA
I <sub>SCP_HVSNK</sub>	HV SNK Switch short protection	HVSNK switch is enabled	-	10	-	8	-	A
HV SRC Switch S	pecifications						1	
I <sub>OCP_HVSRC_ACC</sub>	HV SRC Switch overcurrent	$V_{VCHG}$ =4V to 6v; $\overline{EN}$ = 0 V; $I_{OCP}$ >1A	-10	-	10	-10	10	%
	protection accuracy	$V_{VCHG}$ =4V to 6V; EN = 0 V; I <sub>OCP</sub> <1A	-20	-	20	-20	20	%
V <sub>RCP_HVSRC</sub>	HV SRC RCP trig level	V <sub>RCP_HVSRC</sub> = V <sub>(VBUS)</sub> - V <sub>(VCHG)</sub>	-	15	-	8	21	mV
V <sub>RCPS_HVSRC</sub>	HV SRC Severe RCP trig level	V <sub>RCP_HVSRC</sub> = V <sub>(VBUS)</sub> - V <sub>(VCHG)</sub>	-	100	-	70	130	mV
I <sub>S(OFF)_HVSRC</sub>	VBUS OFF state leakage	HV SRC Switch OFF; VBUS=5V	-	5	-	-	10	μA
		HV SRC Switch OFF; VBUS=20V	-	15	-	-	30	μA

#### USB PD and Type-C high voltage sink/source combo switch with protection

#### Table 26. Static characteristics...continued

At recommended operating conditions and VDD=3.3V; voltages are referenced to GND (ground = 0 V).

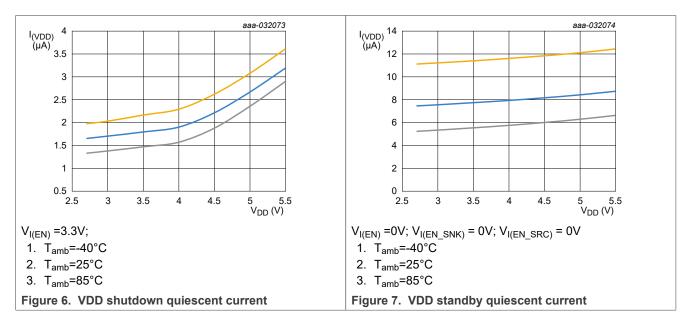
Symbol	Parameter	Conditions	T,	amb = 25	°C	T <sub>amb</sub> = -40 °C to +85 °C		Unit
			Min	Тур	Мах	Min	Max	
	VCHG OFF state leakage	HV SRC Switch OFF; VCHG=5V	-	1	-	-	5	μA
I <sub>S(ON)_HVSRC</sub>	RCP Leakage current	EN = 0 V; HVSRC switch is enabled; VCHG=0V; VBUS=5V	-	1	-	-	5	μA
I <sub>SCP_HVSRC</sub>	HV SRC Switch short protection	HVSRC switch is enabled and at normal operation	-	10	-	7	-	A
		HVSRC switch is enabled and after OCP triggered	-	6.5	-	4.5	-	A
5V SRC Switch S	Specifications						1	-
I <sub>OCP_5VSRC_ACC</sub>	5V SRC Switch overcurrent	$V_{V5V}$ =4V to 5.5V; $\overline{EN}$ = 0 V; $I_{OCP}$ >1A	-	-	-	-10	10	%
	5V SRC RCP trig	$V_{V5V}$ =4V to 5.5V; $\overline{EN}$ = 0 V; I <sub>OCP</sub> >1A	-	-	-	-20	20	%
V <sub>RCP_5VSRC</sub>	5V SRC RCP trig level	$V_{\text{RCP}_5\text{VSRC}} = V_{(\text{VBUS})} - V_{(\text{V5V})}$	-	10	-	6	14	mV
V <sub>RCPS_5VSRC</sub>	5V SRC Severe RCP trig level	$V_{\text{RCP}_5\text{VSRC}} = V_{(\text{VBUS})} - V_{(\text{V5V})}$	-	60	-	40	80	mV
I <sub>S(OFF)_5</sub> vsrc	VBUS OFF state leakage	5V SRC Switch OFF; VBUS=5V	-	5	-	-	10	μA
		5V SRC Switch OFF; VBUS=20V	-	15	-	-	30	μA
	V5V OFF state leakage	5V SRC Switch OFF; V5V=5V	-	1	-	-	5	μA
I <sub>S(ON)_5VSRC</sub>	RCP Leakage current	EN = 0 V; 5VSRC switch is enabled; V5V=0V; VBUS=5V	-	1	-	-	5	μA
I <sub>SCP_5VSRC</sub>	5V SRC Switch short protection	5VSRC switch is enabled and at normal operation	-	7	-	5	-	A
		5VSRC switch is enabled and after OCP triggered	-	6	-	4.5	-	A
I <sup>2</sup> C-bus Interface	Specifications							
V <sub>IH</sub>	HIGH-level input voltage	SCL, SDA; VDD= 2.7V to 5.5V	1.2	-	-	1.2	-	V
V <sub>IL</sub>	LOW-level input voltage	SCL, SDA; VDD= 2.7V to 5.5V	-	-	0.4	-	0.4	V
V <sub>OL</sub>	LOW-level output voltage	$\overline{\text{INT}}$ pin; VDD= 2.7V to 5.5V; I <sub>load</sub> = 1mA	-	-	0.4	-	0.4	V
f <sub>CLK_I2C</sub>	I <sup>2</sup> C bus clock frequency		0	-	1	0	1	MHz
Thermal Protect	ion							

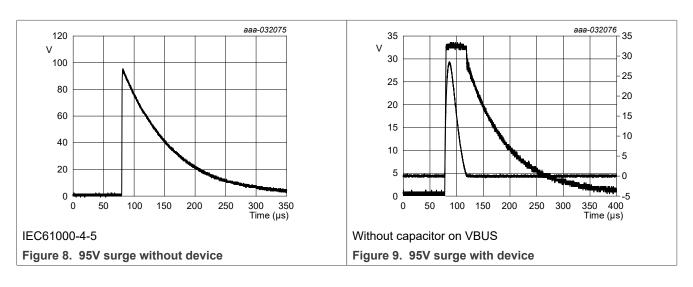
#### Table 26. Static characteristics...continued

At recommended operating conditions and VDD=3.3V; voltages are referenced to GND (ground = 0 V).

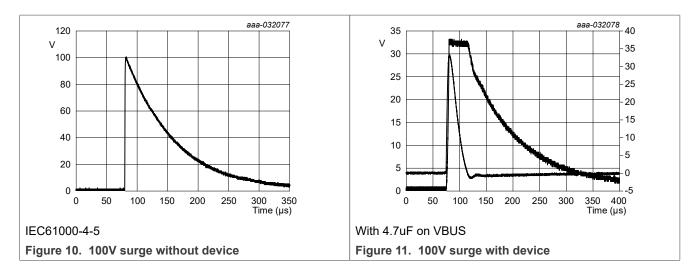
Symbol Parameter Conditions		T <sub>amb</sub> = 25 °C			T <sub>amb</sub> = - +85 °C	Unit		
			Min	Тур	Мах	Min	Max	
T <sub>th(otp)</sub>	over temperature shutdown threshold temperature	VDD=2.7V to 5.5V	-	140	-	-	-	°C
T <sub>th(otp)hys</sub>	hysteresis of over temperature protection threshold temperature	VIN=2.7V to 5.5V	-	20	-	-	-	°C

#### 13.1 Graphs





USB PD and Type-C high voltage sink/source combo switch with protection



### 13.2 ON resistance

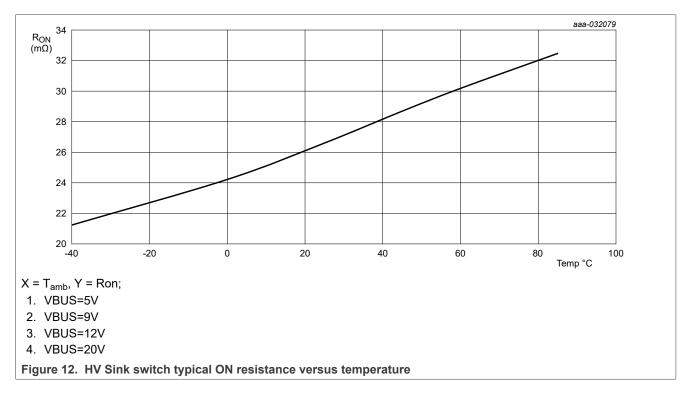
# Table 27. ON resistance

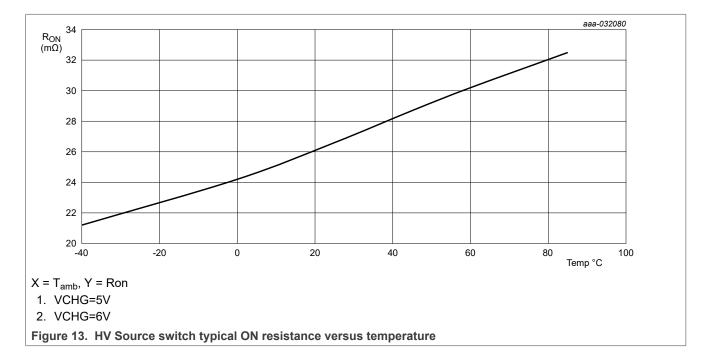
At recommended operating conditions; voltages are referenced to GND (ground = 0 V)

Symbol	Parameter	Conditions	Ta	<sub>mb</sub> = 25	°C	T <sub>amb</sub> = -40	Unit	
			Min	Тур	Мах	Min	Max	
R <sub>ON_HVSNK</sub>	ON resistance	I <sub>LOAD</sub> = 1 A						
		V <sub>I(VBUS)</sub> = 5.0 V	-	28	32	-	42	mΩ
		V <sub>I(VBUS)</sub> = 20 V	-	28	32	-	42	mΩ
R <sub>ON_HVSRC</sub>	ON resistance	I <sub>LOAD</sub> = 1 A						
		V <sub>I(VCHG)</sub> = 5.0 V	-	28	32	-	42	mΩ
R <sub>ON_5VSRC</sub>	ON resistance	I <sub>LOAD</sub> = 1 A						
		V <sub>I(V5V)</sub> = 5.0 V	-	38	43	-	57	mΩ

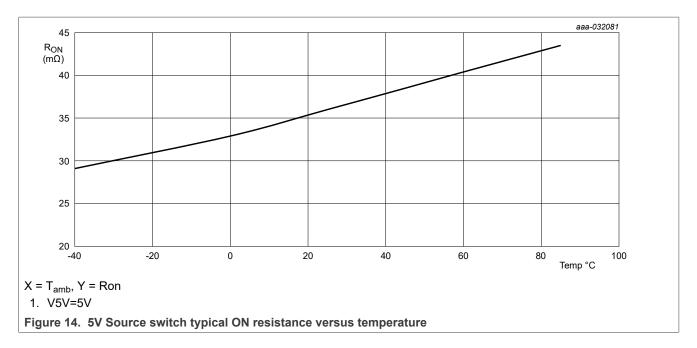
#### USB PD and Type-C high voltage sink/source combo switch with protection

### 13.3 ON resistance graphs





USB PD and Type-C high voltage sink/source combo switch with protection



# 14 Dynamic characteristics

 Table 28. Dynamic characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); for test circuit see Figure 16.

Symbol	Parameter	Conditions	Ta	amb = 25	°C	T <sub>amb</sub> = -40 °C to +85 °C		Unit
			Min	Тур	Max	Min	Мах	
HV SNK Switch	specifications							
t <sub>DEB_HVSNK</sub>	HV SNK Switch De-bounce time	Time from V <sub>UVLO</sub> <vbus<v<sub>OVLO to V<sub>(VCHG)</sub> = 10% of V<sub>(VBUS)</sub></vbus<v<sub>	-	15	-	-	-	ms
t <sub>tlh_hvsnk</sub>	HV SNK Switch VCHG rise time	$V_{(VCHG)}$ from 10% to 90% $V_{(VBUS)}$ ; C <sub>Load</sub> = 22µF; R <sub>Load</sub> = 100Ω						
		V <sub>I(VIN)</sub> = 5V	-	1.8	-	-	2.7	ms
		V <sub>I(VIN)</sub> = 20V	-	2.3	-	-	3.5	ms
t <sub>dis(OVP)</sub>	OVLO turn off time	$ \begin{array}{l} \mbox{From $V_{(VBUS)}$} \mbox{V}_{OVLO}$ to $V_{(VCHG)}$ = 80\% of $V_{(VIN)}$; $R_{Load}$ = 100\Omega$; $C_{Load}$ = 0 $\mu$F; $V_{I(VBUS)}$ = 20V$; $VIN$ rise $>2V$/us  $	-	30	-	-	100	ns
t <sub>dis_HVSNK</sub>	HV SNK Switch Disable time	$ \begin{array}{l} \mbox{From EN to V}_{(VBUS)} = 90\% \mbox{ of } \\ \mbox{V}_{(VIN)}; \mbox{V}_{I(VIN)} = 5V;  C_{Load} = 0\mu\mbox{F}; \\ \mbox{R}_{Load} = 100\Omega \end{array} $	-	5	-	3	7	μs
t <sub>dis(RCPS)_</sub> HVSNK	HV SNK Switch Severe RCP Disable time	From HV Sink Severe RCP to switch turn off	-	3.5	-	3	4	μs
t <sub>degl_HVSNK</sub>	HV SNK Switch RCP de-glitch time	Time from V <sub>UVLO</sub> <vin<v<sub>OVLO to V<sub>(VCHG)</sub> = 10% of V<sub>(VIN)</sub></vin<v<sub>	-	4	-	-	-	ms

NX20P3483AUK Product data sheet

#### USB PD and Type-C high voltage sink/source combo switch with protection

#### Table 28. Dynamic characteristics...continued

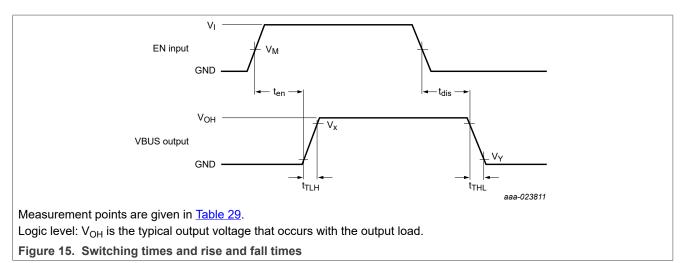
At recommended operating conditions; voltages are referenced to GND (ground = 0 V); for test circuit see Figure 16.

Symbol	Parameter	Conditions	T,	<sub>amb</sub> = 25	°C	T <sub>amb</sub> = -4 +85 °C	40 °C to	Unit
			Min	Тур	Мах	Min	Мах	-
t <sub>SCP_HVSNK</sub>	Short circuit protection response time	VBUS=5V; Time from short circuit happened to switch turn off	-	2.5	-	-	-	μs
HV SRC Switch	specifications						1	
t <sub>EN_HVSRC</sub>	HV SRC Switch Enable time	EN_SRC= HIGH to $V_{(VBUS)}$ = 10% of $V_{(VCHG)}$ ; $C_{Load}$ = 10µF; $R_{Load}$ = 100Ω	-	5	-	-	9	ms
t <sub>TLH_HVSRC</sub>	HV SRC Switch VBUS rise time							
		V <sub>I(VCHG)</sub> = 5V	-	1.8	-	-	2.7	ms
t <sub>dis_HVSRC</sub>	HV SRC Switch Disable time	$ \begin{array}{l} EN\_SRC=LOW \ to \ V_{(VBUS) = 90\%} \\ of \ V_{(VCHG); \ V_{I(VCHG)} = 5V; \ C_{Load} = } \\ 0\muF; \ R_{Load} = 100\Omega \end{array} $	-	5	-	3	7	μs
t <sub>dis(RCPS)_</sub> HVSRC	HV SRC Switch Severe RCP Disable time	From HV source severe RCP to switch turn off	-	1	-	-	2	us
t <sub>degl_RCP_HVSRC</sub>	HV SRC Switch RCP de-glitch time	Time from V <sub>UVLO</sub> <vchg<v<sub>OVLO to V<sub>(VCHG)</sub> = 10% of V<sub>(VIN)</sub></vchg<v<sub>	-	4	-	-	-	ms
t <sub>degl_OCP_HVSRC</sub>	HV SRC Switch OCP de-glitch time	De-glitch Time from overcurrent to OC_HVSRC interrupt	-	8	-	-	-	ms
t <sub>SCP_HVSRC</sub>	Short circuit protection response time	VCHG=5V; Time from short circuit happened to switch turn off	-	1	-	-	-	μs
5V SRC Switch	specifications			1		-	1	
t <sub>EN_5</sub> vsrc	5V SRC Switch Enable time	EN_SRC=HIGH to $V_{(VBUS)}$ = 90% of $V_{(V5V)}$ ; $C_{Load}$ = 10µF; $R_{Load}$ = 100Ω						
		Non Fast role swap mode	-	2.8	-	-	-	ms
		Fast role swap mode	-	60	-	-	90	μs
t <sub>TLH_5VSRC</sub>	5V SRC Switch VCHG rise time							-
		Non Fast role swap mode	-	1.3	-	-	-	ms
		Fast role swap mode	-	50	-	-	80	μs
t <sub>dis_5VSRC</sub>	5V SRC Switch Disable time	$ \begin{array}{l} EN\_SRC=LOW \ to \ V_{(\mathsf{VBUS)} = 90\%} \\ of \ V_{(\mathsf{V5V)}; \ V_{I(V5V)} = 5V; \ C_{Load} = } \\ 0\muF; \ R_{Load} = 100\Omega \end{array} $	-	5	-	3	7	μs
t <sub>dis(RCPS)_</sub> 5VSRC	5V SRC Switch RCP Disable time	From VBUS>V5V+50mV to switch turn off	-	1	-	-	1.5	μs

#### Table 28. Dynamic characteristics...continued

Symbol	Parameter	Conditions		T <sub>amb</sub> = 25 °C			T <sub>amb</sub> = -40 °C to +85 °C	
			Min	Тур	Мах	Min	Max	
t <sub>degl_RCP_5VSRC</sub>	5V SRC Switch RCP de-glitch time	Time from $V_{UVLO}$ to $V_{(VCHG)}$ = 10% of $V_{(VIN)}$	-	4	-	-	-	ms
$t_{degl_OCP_5VSRC}$	5V SRC Switch OCP de-glitch time	De-glitch Time from overcurrent to OC_5VSRC interrupt	-	8	-	-	-	ms
t <sub>SCP_5VSRC</sub>	Short circuit protection response time	V5V=5V; Time from short circuit happened to switch turn off	-	0.5	-	-	-	μs
t <sub>vbusdischarge</sub>	Time taken for VIN discharge	VDD= 3.3V; Load Capacitance = 10µF VBUS pin going down below Vsafe0V after VBUS detached and switch disabled	-	-	-	-	650	ms
		VDD= 3.3V; Load Capacitance = 10µF VBUS pin going down below Vsafe5V (when initial voltage is >5V) after VBUS detached and switch disabled	-	-	-	-	275	ms

### 14.1 Waveform and test circuits



#### Table 29. Measurement points

Supply voltage	EN Input	Output			
V <sub>I(VIN)</sub>	V <sub>M</sub>	V <sub>X</sub>	V <sub>Y</sub>		
5.0 V; 20.0V	$0.5 \times V_{I(EN)}$	0.9 × V <sub>OH</sub>	0.1 × V <sub>OH</sub>		

#### USB PD and Type-C high voltage sink/source combo switch with protection

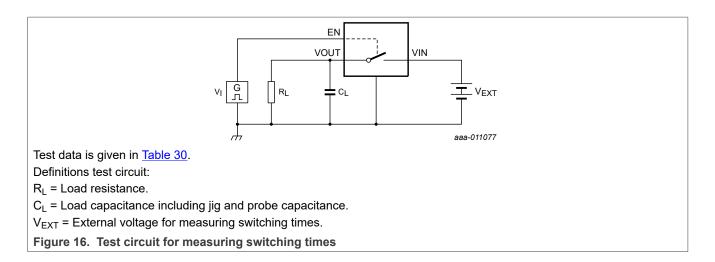
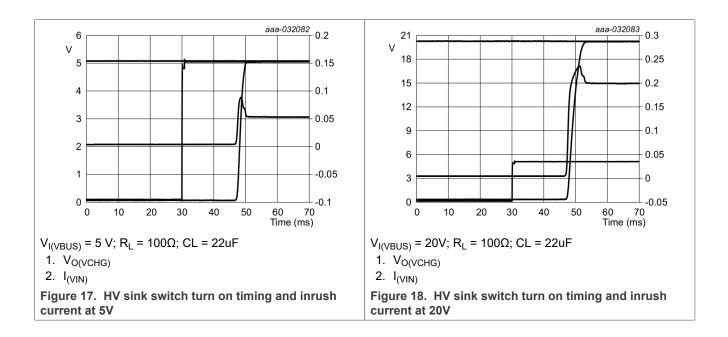
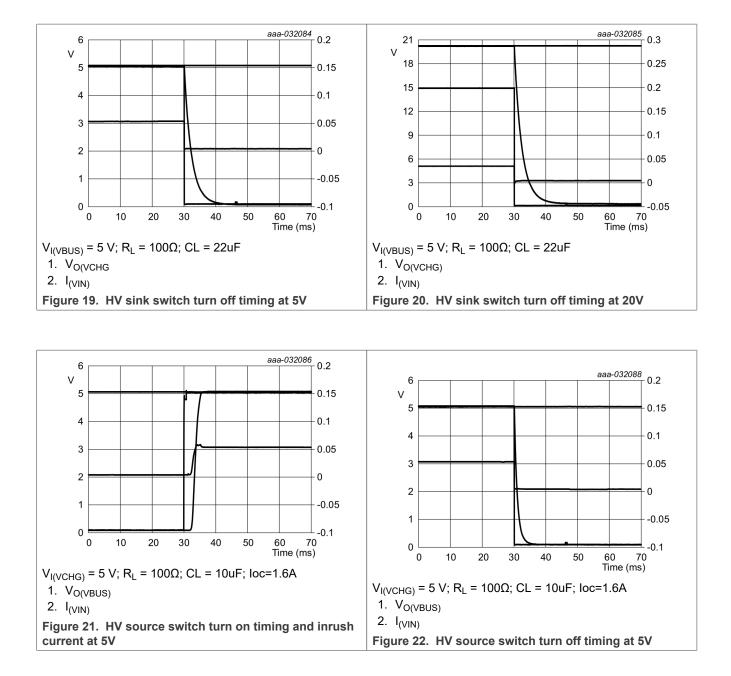


Table 30. Test data

Supply voltage	EN Input	Load		
V <sub>EXT</sub>	V <sub>I(EN)</sub>	CL	R <sub>LOAD</sub>	
5.0 V; 20.0V	0 to V <sub>I(VIN)</sub>	22 µF	100 Ω	



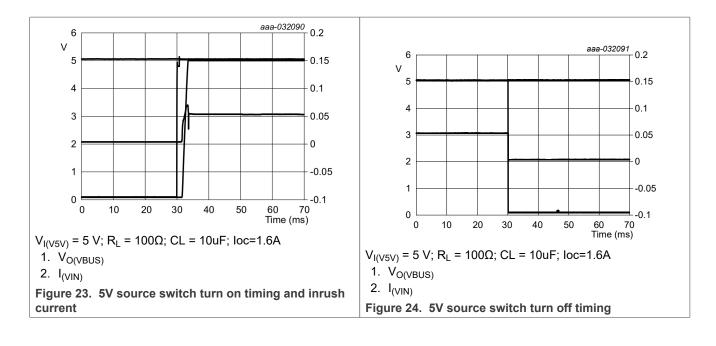


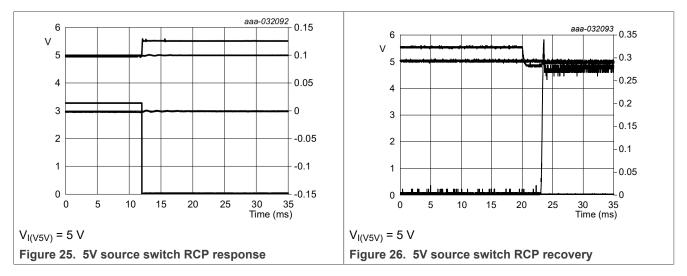
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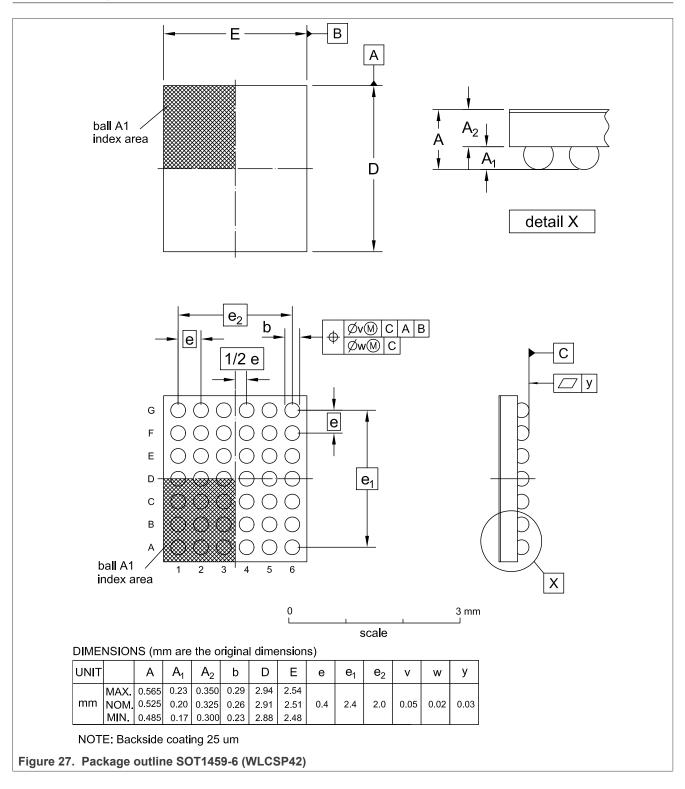
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USB PD and Type-C high voltage sink/source combo switch with protection





# 15 Package outline



### **16 Packing information**

# 16.1 SOT1459-6 (WLCSP42); reel dry pack, SMD, 7" Q1 standard product orientation ordering code (12NC) ending 012

#### 16.1.1 Dimensions and quantities

#### Table 31. Dimensions and quantities

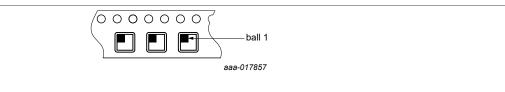
	[2]	Reels per box
180 × 12	2000	1

[1] d = reel diameter; w = tape width.

[2] Packing quantity dependent on specific product type.

View ordering and availability details at <u>NXP order portal</u>, or contact your local NXP representative.

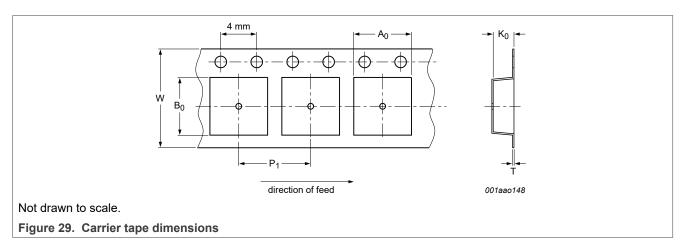
#### **16.1.2** Product orientation



Ball 1 is in quadrant 1

#### Figure 28. Product orientation in carrier tape

#### 16.1.3 Carrier tape dimensions



#### Table 32. Carrier tape dimensions

In accordance with IEC 60286-3.

A <sub>0</sub> (mm)	B <sub>0</sub> (mm)	K <sub>0</sub> (mm)	T (mm)	P <sub>1</sub> (mm)	W (mm)
2.71 ± 0.05	3.11 ± 0.05	0.72 ± 0.05	0.25 ± 0.02	8.0 ± 0.10	12 +.30/10

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# **17 Abbreviations**

Table 33. Abbreviations		
Acronym	Description	
ESD	ElectroStatic Discharge	
CDM	Charged Device Model	
HBM	Human Body Model	
USB	Universal Serial Bus	
VOIP	Voice over Internet Protocol	

# 18 Revision history

# Document ID Release date Description NX20P3483AUK v.1.0 20250303 • Initial version

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# Legal information

### Data sheet status

Document status <sup>[1][2]</sup>	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
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